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P.J. Carberry 4

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**Patent Application**

Applicant(s): Patrick J. Carberry
Case: 4
Serial No.: 10/881,191
Filing Date: June 30, 2004
Group: To Be Assigned
Examiner: To Be Assigned

I hereby certify that this paper is being deposited on this date with the U.S. Postal Service as first class mail addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Signature: 

Date: August 9, 2004

Title: Methods and Apparatus for Integrated Circuit
Ball Bonding Using Stacked Ball Bumps

TRANSMITTAL OF FORMAL DRAWINGS

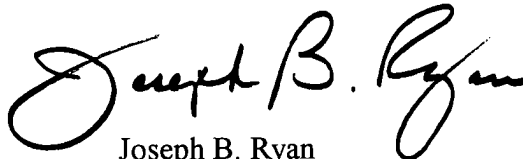
Mail Stop PGPUB Drawings
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Attention: Official Draftsperson

Sir:

Applicant submits herewith three (3) sheets of formal drawings in the above-referenced application.

Respectfully submitted,



Date: August 9, 2004

Joseph B. Ryan
Reg. No. 37,922
Ryan, Mason & Lewis, LLP
Attorney for Applicant(s)
90 Forest Avenue
Locust Valley, NY 11560
(516) 759-7517